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ABSTRACT

An electronic control device case prevents a gap provided therein. The electronic control device case includes: a body case including a bottom plate and a pair of side walls bent at and extended from both ends of the bottom plate and having a front opening; and a cover including a front plate closing the front opening of the body case. The body case includes a first flange bent at a front end of the bottom plate, and second flanges bent at respective front ends of the pair of side walls. The first flange is positioned on a first plane. The second flanges are positioned on a second plane different from the first plane. The first flange pushes a back surface at a lower edge of the front plate of the cover. The second flanges push front surfaces at both side ends of the front plate of the cover. In this configuration, the edge of the front plate of the cover is sandwiched and held between the first flange and each second flange.

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